



#### **Interactions of Particles and Matter**

- understanding the LHC detectors requires a basic understanding of the interaction of high energy particles and matter
- we will cover here:
  - photons/electrons in nuclear materials (em cal.)
  - bremsstrahlung
  - minimum ionization (charged tracks)
  - multiple scattering
  - secondary hadron production/nuclear interaction

see http://pdg.lbl.gov/2005/reviews/passagerpp.pdf



Photons in matter:

- low energies (< 100 keV): photoelectric effect
- medium energy (~ 1 MeV): Compton scattering
- high energy (> 10 MeV):
   e<sup>+</sup>e<sup>-</sup> pair production

Each of these leads to electrons being ejected from atoms...e.m. showers



#### **Photons and Matter**

- we are mainly interested in very high energy photons,  $E_{\gamma} > 1$  GeV where pair production dominates
- a beam of such high energy photons has an intensity which drops exponentially with depth:

$$I(x) = I_0 e^{-\mu x}$$

 μ is the linear absorption coefficient; probability of radiation per unit distance traversed:

• but then we have high energy electrons...process repeats



| Radiation Leng   | gth            |                                     |
|--|----------------|-------------------------------------|
| $1/X_0 = \frac{4\alpha N_A Z(Z+1) r_e^2 \log(1)}{A}$                                     | $83Z^{-1/3})$  |                                     |
| <ul> <li>higher Z materials have shorter<br/>radiation length</li> </ul>                 | material       | X <sub>0</sub><br>g/cm <sup>2</sup> |
| <ul> <li>want high-Z material for e.m.<br/>calorimeter</li> </ul>                        | H <sub>2</sub> | 63                                  |
| <ul> <li>want as little material as possible in<br/>front of the calorimeter!</li> </ul> | AI             | 24                                  |
|  | Fe             | 13.8                                |
| • lead: $\rho = 11.4 \text{ g/cm}^3$   | Pb             | 6.3                                 |
| $\Rightarrow X_0 = 5.5 \text{ mm}$   |                |                                     |



### **Hadronic Showers**

- interactions of pions/kaons in material: nuclear interaction length
- lead ~ steel = 17 cm
- about 5% different for pi<sup>+</sup> and pi<sup>-</sup>
- for heavy (high Z) materials we see that the nuclear interaction length is a lot longer than the electromagnetic one

|  | material       | X <sub>0</sub> (g/cm <sup>2</sup> ) | $\lambda_n$ (g/cm <sup>2</sup> ) |  |
|--|----------------|-------------------------------------|----------------------------------|--|
| <ul> <li>snowers start late,<br/>more diffuse</li> </ul>       | H <sub>2</sub> | 63                                  | 52.4                             |  |
|  | AI             | 24                                  | 106                              |  |
| <ul> <li>and don't forget</li> <li>charge exchange!</li> </ul> | Fe             | 13.8                                | 132                              |  |
| charge exchange:   | Pb             | 6.3                                 | 193                              |  |

## **Bethe-Bloch and MIPs**

- high energy charged particles lose energy by ionization of atoms
- specific ionization (dE/dx) depends on material density
- express in terms of MeV/(g/cm<sup>2</sup>)
- $1/\beta^2$ , rel. rise.
- minimum at  $\beta \gamma \sim 3$



#### **Bethe-Bloch and MIPs**

 $-\frac{dE}{dx} = Kz^2 \frac{Z}{A} \frac{1}{\beta^2} \left[\frac{1}{2} ln \frac{2m_e c^2 \beta^2 \gamma^2 T_{max}}{I^2} - \beta^2 - \frac{\delta}{2}\right]$ 

- Bethe-Block formula describes <u>average</u> energy loss
- example: MIP in silicon

dE/dx: 1.6 MeV/(g/cm2) x 2.33 g/cm<sup>3</sup>

= 3.7 MeV/cm (not much!)

 amount of ionization fluctuates according to "Landau" distribution (actually Vavilov)



## **Multiple Scattering**

- as they ionize materials, high energy charged particles change their direction with each interaction
- distribution dominated by gaussian of width  $\theta_0$
- high angle scattering tail to distribution
- important for relatively low-energy particles (~ few GeV): rms angle given by

$$heta_0 = rac{13.6 {
m MeV}}{eta c p} z \sqrt{x/X_0} \left[1 + 0.038 \ln(x/X_0)
ight]$$

• for a 1 GeV pion traversing 1 X<sub>0</sub>,  $\theta_0 \sim 14$  mrad

• for a 10 GeV pion traversing 1  $X_0$ ,  $\theta_0 \sim 1.4$  mrad

## Muon Bremsstrahlung

1000

- muons are much heavier than electrons, but at high energies radiative losses begin to dominate:
- in other words, at high energies muons can sometimes behave more like electrons!



- effective radiation length decreases at high energy and so (late) e.m. showers can develop in the detector
- pions, too, but that's less of a problem...

## **Tracking Detectors**

- For tracking detectors we want as little material as possible to minimize multiple scattering; two approaches:
  - gas/wire chambers (like CDF's COT)
  - solid-state detectors (silicon)
- Silicon is now the dominant sensor material in use for tracking detectors at the LHC and we will focus on that
- however, first a word about drift chambers...

# **Drift Cells**

- tubes with wire at +HV draw ionization electrons; avalanche near wire
- stack up the tubes, measure time of arrival of the ionization pulse
- drift: ~5 cm/μs (50 μm/ns)
- find track from tangents to circles
- can get about 150 µm position resolution
- but: a lot of material!

- in doped silicon can create "p-n" junction
- free carriers diffuse across junction, electrons neutralizing the holes:



- applying very large reverse-bias voltage to p-n junction "fully depletes" the silicon, leaving E field
- for 300  $\mu$ m thickness, typically V<sub>b</sub> ~ 100 V
- geometry of typical silicon detector:



- pixel detector: deposited charge sensed by small pixels on one side of sensor
  - many channels, expensive
  - more material
  - easy pattern recognition
- strip detector: deposited charge sensed by long narrow strips
  - fewer channels, less expensive
  - less material
  - pattern recognition difficult!

- charge sharing used to determine where charged particle passed through detector
- can get resolution much smaller than strip or pixel size, onthe order of 10-20 μm







## Calorimetry

- want heavy material to cause brem/pair production for initial electromagnetic section, and fine sampling
- for hadron calorimetry, larger towers and coarser sampling in depth
- two technologies for em calorimeters:
  - exotic crystals (CsI, PbWO, BGO, ...)
  - liquid argon
- can achieve remarkable precision
- relative energy uncertainty decreases with E !



## **CMS and ATLAS**

- two different approaches to the LHC problem!
- CMS sinks, ATLAS floats!
- both need to employ detectors with very fast signals and readout
- both need to be very radiation hard

|          | ATLAS        | CMS          |
|----------|--------------|--------------|
| tracking | silicon/gas  | silicon      |
| em cal   | liquid Ar    | PbWO         |
| had cal  | steel/scint. | brass/scint. |
| muon     | RPCs/drift   | RPCs/drift   |







## **ATLAS Inner Detector**

• silicon pixels surrounded by silicon strips:

• 2 Tesla solenoid immediately outside tracker











#### **CMS Electromagnetic Calorimeter**

- lead tungstate crystals
- projective geometry
- avalanche photodiode readout















This is from test beams - does not tell the whole story!

# **Material Budget**

2

1.5

0.5

×1×









## The Mystery of Triggering

- at the design rate, every beam crossing gives a collision (usually minimum bias)
- cannot read out detector on every event (1Mb/event)
- do not have bandwidth to store events
- cannot process every event later
- must have trigger to decide what to keep/reject
- trigger is very sophisticated and complicated!
- triggers are arranged in levels of increasing complexity, and decreasing rate



## **CMS Level 1 Trigger**



## **CMS L1 Thresholds**

• need energy thresholds to control rates!

|                   |            | AND ADDRESS AND ADDRESS |      |               |            |              |               |             |
|-------------------|------------|---|------|---------------|------------|--------------|---------------|-------------|
|                   | е          | ee  | τ    | ττ            | j          | jj           | jijj          | jjjj        |
| Low $\mathcal{L}$ | 24         | 18  | 95   | 75            | 150        | 115          | 95            | 75          |
| High ${\cal L}$   | 35         | 20  | 180  | 110           | 285        | 225          | 125           | 105         |
|                   | τ <b>e</b> | je  | MET  | <b>e</b> +Met | ј+МЕТ      | e(NI)        | ee(NI)        | $\Sigma$ et |
| Low $\mathcal L$  | 80,14      | 125,14  | 275  | 12,175        | 65,175     | NA*          | NA*           | 1000        |
| High ${\cal L}$   | 125,20     | 165,20  | 350  | 18,250        | 95,250     | 58           | 28            | 1500        |
|                   | μ          | μμ  | μ    | μτ            | μ <b>j</b> | µ+ <b>ET</b> | μ <b>+ΜΕΤ</b> | Rate:       |
| Low $\mathcal L$  | 10         | 3   | 4,12 | 4,80          | 4,80       | 4,600        | 4,140         | 25 kHz      |
| High $\mathcal L$ | 25         | 8,5   | 5,32 | 5,140         | 5,155      | 5,800        | 5,200         | 25 kHz      |

# **ATLAS L1 Thresholds**

| Selection High-p <sub>T</sub> Thresholds | 2 x 10 <sup>33</sup> cm <sup>-2</sup> s <sup>-1</sup> | 10 <sup>34</sup> cm <sup>-2</sup> s <sup>-1</sup> |
|--|---|---|
| MU20 (20)                                | 0.8   | 4.0   |
| 2MU6                                     | 0.2   | 1.0   |
| EM25I (30)                               | 12.0  | 22.0  |
| 2EM15I (20)                              | 4.0   | 5.0   |
| (290)                                    | 0.2   | 0.2   |
| 3J90 (130)                               | 0.2   | 0.2   |
| 4J65 (90)                                | 0.2   | 0.2   |
| (60 + xE60) (100+100)                    | 0.4   | 0.5   |
| (60+60)                                  | 2.0   | 1.0   |
| MU10 + EM15I                             | 0.1   | 0.4   |
| Others (pre-scales, calibration, ?)      | 5.0   | 5.0   |
| Fotal                                    | ~ 25  | <b>~</b> 40                                       |

## Analyzing the Data

- calibration/alignment studies
  - offline corrections
    - cal clusters  $\rightarrow$  jets, electrons, etc.
    - tracker hit clusters  $\rightarrow$  track segments  $\rightarrow$  tracks
      - high level objects:  $e/\gamma$ ,  $\mu$ ,  $\tau$ , jets, ...
- perform primary reconstruction
- split into data streams
- distribute to computing centers for selection
- lather, rinse, and repeat...